



SBR02U100LP

0.2A SBR[®] SURFACE MOUNT SUPER BARRIER RECTIFIER

Features

- Ultra Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability



Case: DFN1006-2

- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Dot
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.001 grams







Bottom View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|--|---------------------|-------|------|
| Peak Repetitive Reverse Voltage | V_{RRM} | | |
| Working Peak Reverse Voltage | V_{RWM} | 100 | V |
| DC Blocking Voltage | V_{RM} | | |
| RMS Reverse Voltage | V _{R(RMS)} | 70 | V |
| Average Rectified Output Current (See Figure 1) | Io | 250 | mA |
| Non-Repetitive Peak Forward Surge Current 8.3ms | l=a | E | Λ |
| Single Half Sine-Wave Superimposed on Rated Load | IFSM | 5 | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Maximum Thermal Resistance | | | |
| Thermal Resistance, Junction to Ambient (Note 2) T _A = 25°C | $R_{\theta JA}$ | 270 | °C/W |
| Thermal Resistance, Junction to Ambient (Note 3) T _A = 25°C | $R_{\theta JA}$ | 235 | |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

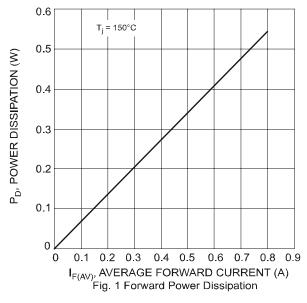
Electrical Characteristics @T_A = 25°C unless otherwise specified

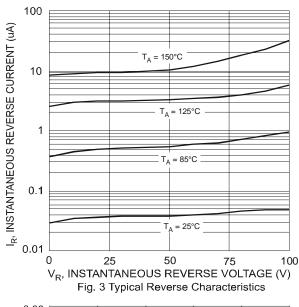
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|--------------------|-----|----------------------|----------------------|------|--|
| Reverse Breakdown Voltage (Note 4) | V _{(BR)R} | 100 | - | - | V | I _R = 1mA |
| Forward Voltage Drop | V _F | - | 0.67 0.76 0.60 | 0.72 0.80 0.65 | V | I _F = 100mA, T _J = 25°C I _F = 200mA, T _J = 25°C I _F = 200mA, T _J = 125°C |
| Leakage Current (Note 4) | I _R | - | 0.04 6 | 1.0 50 | μA | V _R = 75V, T _J = 25°C V _R = 75V, T _J = 85°C |

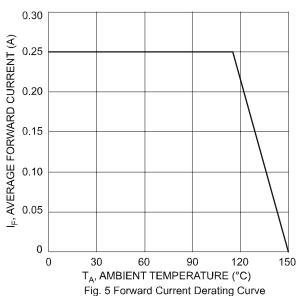
Notes

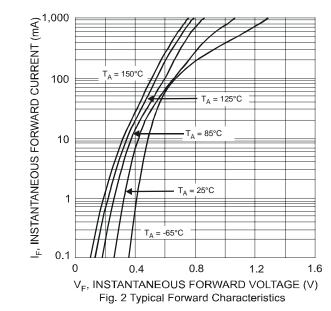
- 1. RoHS revision 13.2.2003. High temperature solder exemption applied, see *EU Directive Annex Note* 7.
- 2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf
- 3. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf
- 4. Short duration pulse test used to minimize self-heating effect.

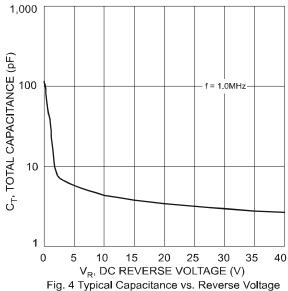


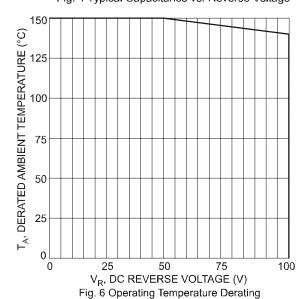












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Ordering Information (Note 5)

| Part Number | Case | Packaging |
|---------------|-----------|------------------|
| SBR02U100LP-7 | DFN1006-2 | 3000/Tape & Reel |

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

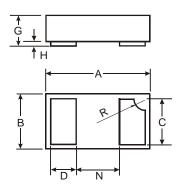
Marking Information





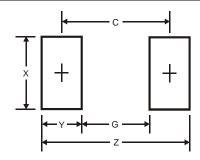
 $\underline{2}$ A, $2\underline{A}$ = Product Type Marking Code Dot Denotes Cathode Side

Package Outline Dimensions



| DFN1006-2 | | | | |
|-----------|----------------------|-------|------|--|
| Dim | Min | Max | Тур | |
| Α | 0.95 | 1.075 | 1.00 | |
| В | 0.55 | 0.675 | 0.60 | |
| С | 0.45 | 0.55 | 0.50 | |
| D | 0.20 | 0.30 | 0.25 | |
| G | 0.47 | 0.53 | 0.50 | |
| Н | 0 | 0.05 | 0.03 | |
| N | _ | _ | 0.40 | |
| R | 0.05 | 0.15 | 0.10 | |
| All [| All Dimensions in mm | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 1.1 |
| G | 0.3 |
| X | 0.7 |
| Y | 0.4 |
| C | 0.7 |

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